



ALPHA & OMEGA
SEMICONDUCTOR

AO4453

12V P-Channel MOSFET

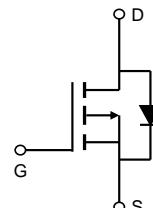
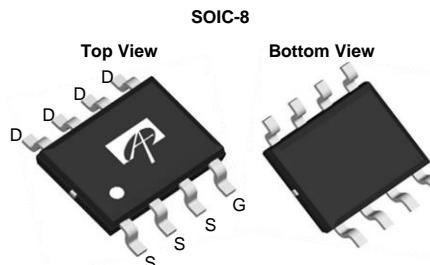
General Description

The AO4453 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

Product Summary

V_{DS}	-12V
I_D (at $V_{GS}=-4.5V$)	-9A
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	< 19mΩ
$R_{DS(ON)}$ (at $V_{GS}=-3.3V$)	< 22mΩ
$R_{DS(ON)}$ (at $V_{GS}=-2.5V$)	< 26mΩ
$R_{DS(ON)}$ (at $V_{GS}=-1.8V$)	< 36mΩ
$R_{DS(ON)}$ (at $V_{GS}=-1.5V$)	< 50mΩ

100% UIS Tested
100% R_g Tested



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current	I_D	-9	A
$T_A=70^\circ\text{C}$		-7	
Pulsed Drain Current ^C	I_{DM}	-55	
Avalanche Current ^C	I_{AS}	20	A
Avalanche energy $L=0.1\text{mH}$ ^C	E_{AS}	20	mJ
Power Dissipation ^B	P_D	2.5	W
$T_A=70^\circ\text{C}$		1.6	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	42	50	°C/W
Maximum Junction-to-Ambient ^{A,D}		70	85	°C/W
Maximum Junction-to-Lead	$R_{\theta JL}$	20	30	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-12			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-12\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1 -5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm8\text{V}$			±100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.3	-0.6	-0.9	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$	-55			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=-4.5\text{V}, I_D=-9\text{A}$ $T_J=125^\circ\text{C}$		15 19.5	19 25	$\text{m}\Omega$
		$V_{GS}=-3.3\text{V}, I_D=-7\text{A}$		17	22	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}, I_D=-6\text{A}$		20	26	$\text{m}\Omega$
		$V_{GS}=-1.8\text{V}, I_D=-4\text{A}$		27	36	$\text{m}\Omega$
		$V_{GS}=-1.5\text{V}, I_D=-1\text{A}$		33	50	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-9\text{A}$		-33		S
V_{SD}	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$		-0.6	-1	V
I_S	Maximum Body-Diode Continuous Current				-3.5	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-6\text{V}, f=1\text{MHz}$		1370		pF
C_{oss}	Output Capacitance			350		pF
C_{rss}	Reverse Transfer Capacitance			258		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		10	20	Ω
SWITCHING PARAMETERS						
$Q_g(4.5\text{V})$	Total Gate Charge	$V_{GS}=-4.5\text{V}, V_{DS}=-6\text{V}, I_D=-9\text{A}$		12.7	18	nC
Q_{gs}	Gate Source Charge			1.7		nC
Q_{gd}	Gate Drain Charge			3.4		nC
$t_{D(\text{on})}$	Turn-On DelayTime	$V_{GS}=-4.5\text{V}, V_{DS}=-6\text{V}, R_L=0.67\Omega, R_{\text{GEN}}=3\Omega$		11		ns
t_r	Turn-On Rise Time			25		ns
$t_{D(\text{off})}$	Turn-Off DelayTime			70		ns
t_f	Turn-Off Fall Time			41.5		ns
t_{rr}	Body Diode Reverse Recovery Time		$I_F=-9\text{A}, dI/dt=100\text{A}/\mu\text{s}$	20.7		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=-9\text{A}, dI/dt=100\text{A}/\mu\text{s}$		5.2		nC

A. The value of R_{JJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using $\leqslant 10\text{s}$ junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

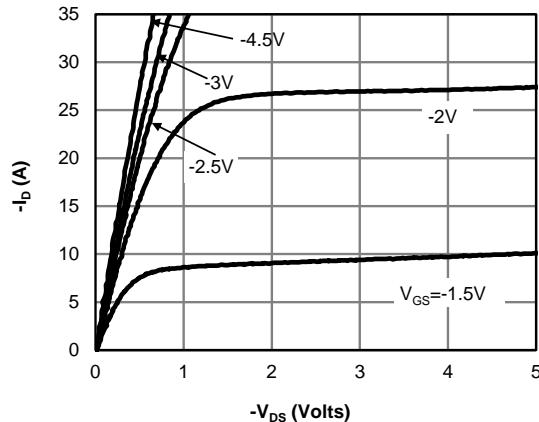
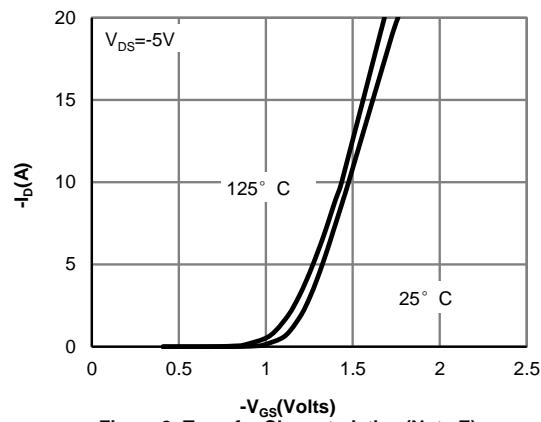
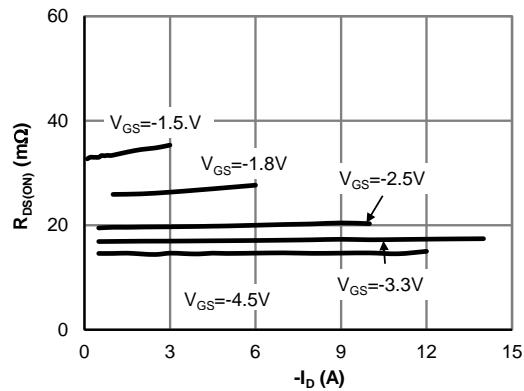
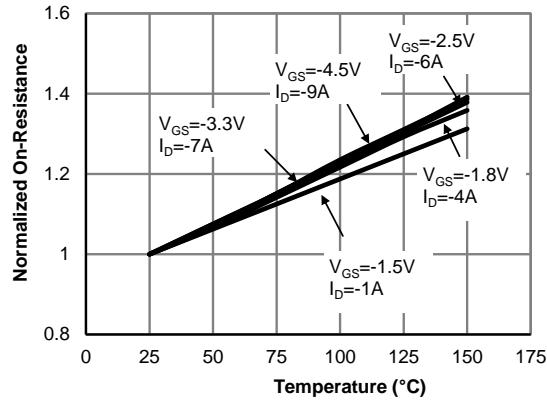
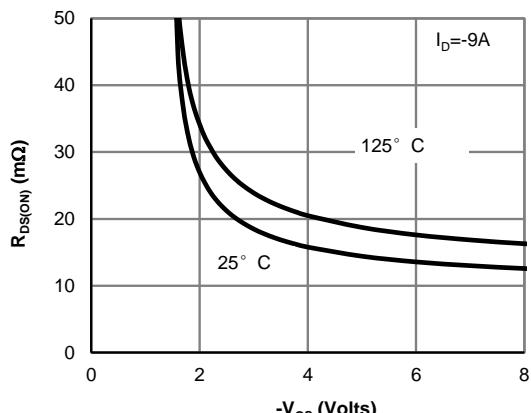
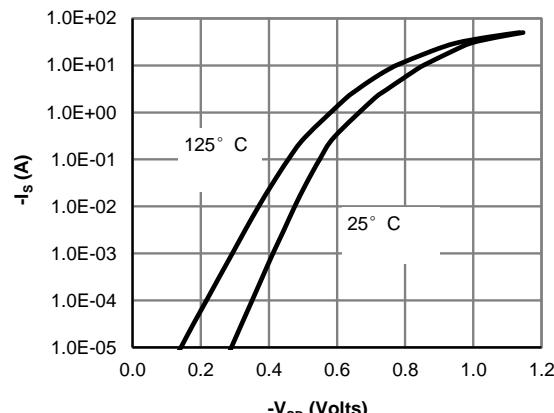
D. The R_{JJA} is the sum of the thermal impedance from junction to lead $R_{J JL}$ and lead to ambient.

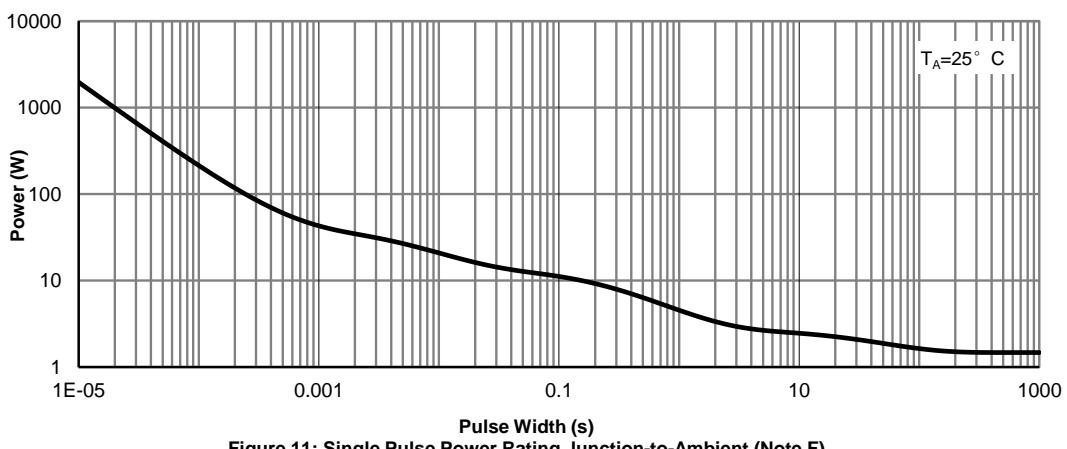
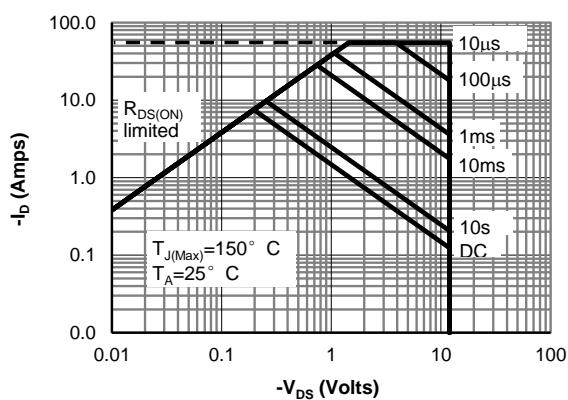
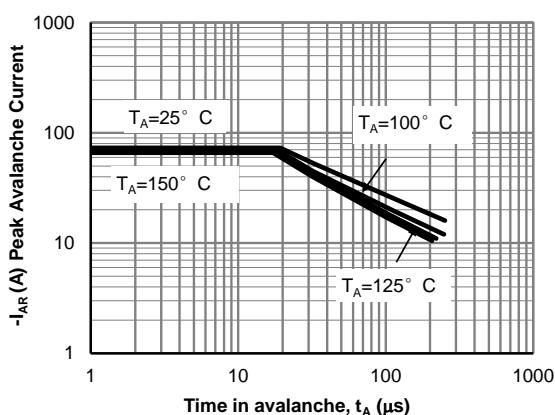
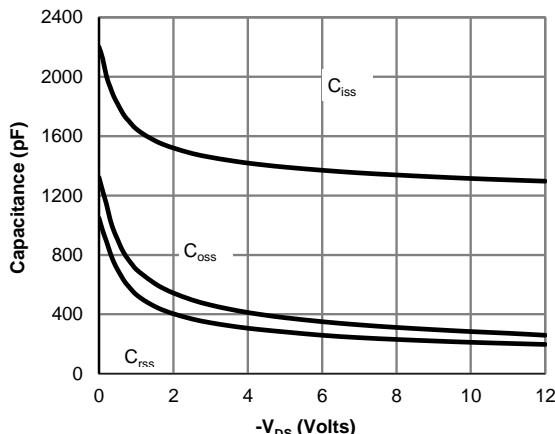
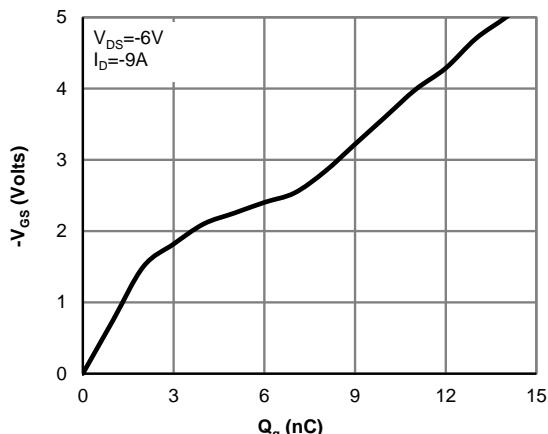
E. The static characteristics in Figures 1 to 6 are obtained using $<300\mu\text{s}$ pulses, duty cycle 0.5% max.

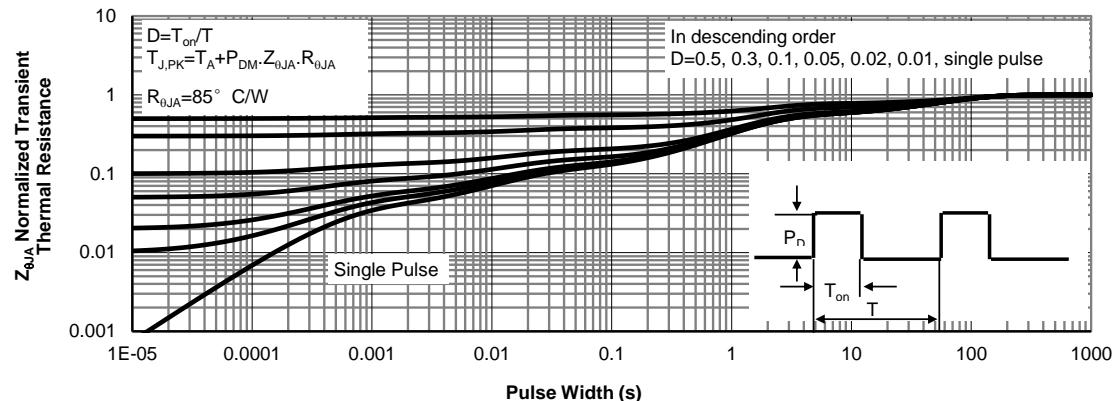
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(\text{MAX})}=150^\circ\text{C}$. The SOA curve provides a single pulse rating.

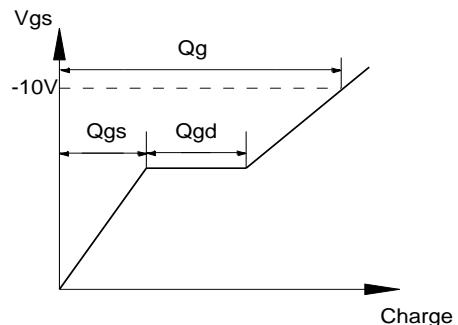
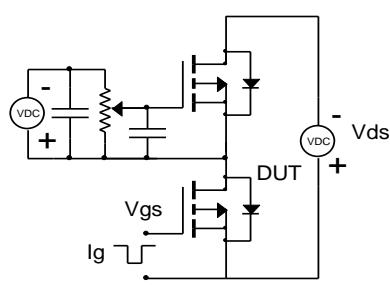
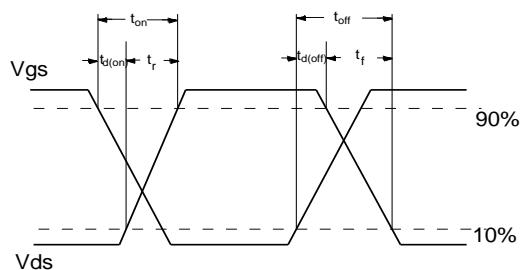
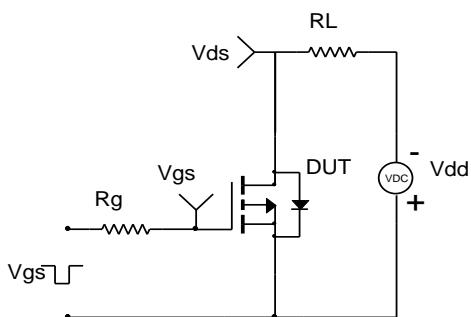
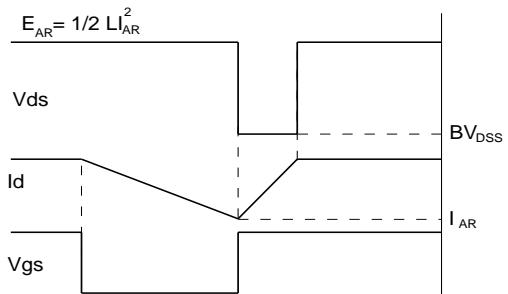
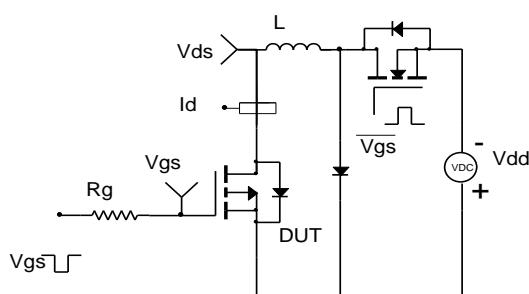
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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)

Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms
